Torm PTO-1595 (Rev. 03-11)

MB No. 0651-0027 (exp. 03/31/2012)

07/23/2012



103647211

U.S. DEPARTMENT OF COMMERCE United States Patent and Trademark Office

PATENTS ONLY

TATENTO ONET	
To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.	
1. Name of conveying party(ies):	Name and address of receiving party(ies)
Yoshifumi Miyajima (06/12/2012) and Katsuya Nakashima (06/24/2012)	Name: Sony Corporation
Additional name(s) of conveying party(ies) attached? Yes X No	Internal Address: Street Address:
3. Nature of conveyance/Execution Date(s): Execution Date(s): in parentheses after inventor name X Assignment Merger Change of Name Security Agreement Joint Research Agreement Government Interest Assignment Executive Order 9424, Confirmatory License Other	1-7-1 Konan Minato-Ku, Tokyo 108-0075 JAPAN City: State: Country: Additional name(s) & address(es) attached?
4. Application or patent number(s): A. Patent Application No.(s) 13/470,907 Additional numbers attached?	his document is being filed together with a new application. B. Patent No.(s) Yes X No
5. Name and address to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Christopher M. Tobin RADER, FISHMAN & GRAUER PLLC	7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00
Internal Address: Atty. Dkt.: SON-5076 Street Address: 1233 20th Street, N.W. Suite 501	X Authorized to be charged to deposit account Enclosed None required (government interest not affecting title)
City: Washington State: DC Zip: 20036 Phone Number: (202) 955-3750	8. Payment Information
Phone Number: (202) 955-3750 Fax Number: (202) 955-3751 Email Address: cmt@radertishman.com	Deposit Account Number 18-0013 Authorized User Name Christopher M. Tobin
Signature: Signature Christopher M Tobin - 40,290 Name of Person Signing	July 18, 2012 Date Date Ditation (International Contents) Sheet, attachments, and documents H 下记录记述 And Main in

PATENT REEL: 028658 FRAME: 0692

Attorney Docket No. 80001-5076 SONY Ref. No.: SP315870US00

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in SEMICONDUCTOR LASER DRIVE CIRCUIT AND SEMICONDUCTOR LASER APPARATUS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in

the spaces that follow: Serial Number: 13/4/0,90/, Filing Date: May 14, 2012. This assignment executed on the dates indicated below.		
YOSHIFUMI MIYAJIMA		
Name of first or sole inventor	Execution date of U.S. Patent Application	
NAGASAKI, JAPAN		
Residence of First or sole inventor foshi (umi Miyajima Signature of first or sole inventor	June 12, 20/2	
Signature of first or sole inventor	Date of this assignment	
KATSUYA NAKASHIMA		
Name of second inventor	Execution date of U.S. Patent Application	
NAGASAKI, JAPAN		
Residence of second inventor		
Signature of second inventor	Date of this assignment	
Name of third inventor	Execution date of U.S. Patent Application	
Decidence of third immedia	• •	
Residence of third inventor		
Signature of third inventor	Date of this assignment	

PATENT REEL: 028658 FRAME: 0693

Attorney Docket No. 80001-5076 SONY Ref. No.: SP315870US00

ASSIGNMENT

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in SEMICONDUCTOR LASER DRIVE CIRCUIT AND SEMICONDUCTOR LASER APPARATUS

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY CORPORATION, a Japanese corporation, with offices at 1-7-1 Konan, Minato-ku, Tokyo, Japan (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in

the spaces that follow: Serial Number: 13/470,907, Filing Date: May 14, 2012.		
This assignment executed on the dates indicated below.		
YOSHIFUMI MIYAJIMA		
Name of first or sole inventor NAGASAKI, JAPAN	Execution date of U.S. Patent Application	
Residence of First or sole inventor		
Signature of first or sole inventor	Date of this assignment	
KATSUYA NAKASHIMA		
Name of second inventor NAGASAKI, JAPAN	Execution date of U.S. Patent Application	
Residence of second inventor	June 24, 2012	
Signature of second inventor	Date of this assignment	
Name of third inventor	Execution date of U.S. Patent Application	
Residence of third inventor		
Signature of third inventor	Date of this assignment	

PATENT REEL: 028658 FRAME: 0694